3.3V 1:4 Clock Fanout **Buffer**

Description

The NB3N2304NZ is a low skew 1-to 4 clock fanout buffer, designed for high speed clock distribution such as in PCI-X applications. The NB3N2304NZ guarantees low output-to-output skew. Optimal design, layout and processing minimizes skew within a device and from device-to-device.

The Output Enable (OE) pin forces the outputs LOW when LOW.

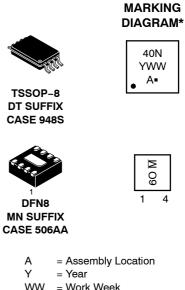
Features

- Input/Output Clock Frequency up to 140 MHz
- Low Skew Outputs (100 ps)
- Output Enable
- Operating Range: $V_{DD} = 3.0 \text{ V}$ to 3.6 V
- Ideal for PCI-X and networking clocks
- Packaged in 8-pin TSSOP, 4.4 mm x 3 mm
- Industrial Temperature Range
- These are Pb-Free Devices*



ON Semiconductor®

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- WW = Work Week = Date Code Μ
 - = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

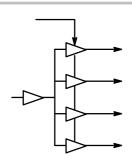


Figure 1. Simplified Logic Diagram

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NB3N2304NZ

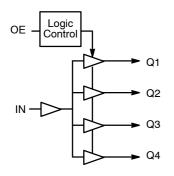


Figure 2. Block Diagram

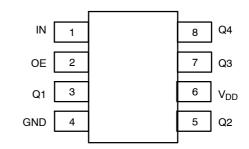


Figure 3. NB3N2304NZ Package Pinout (Top View)

Table 1. PIN DESCRIPTION

Pin #	Pin Name	Туре	Description
1	IN	LVCMOS/LVTTL Input	Clock Input
2	OE	LVCMOS/LVTTL Input	Output Enable for the clock outputs. Outputs are enabled when forced HIGH. Outputs are forced to logic LOW when OE is forced LOW.
3	Q1	LVCMOS/LVTTL Output	Clock Output 1
4	GND	Power	Negative Supply Voltage; Connect to Ground, 0 V
5	Q2	(LV)CMOS/(LV)TTL Input	Clock Output 2
6	V _{DD}	Power	Positive Supply Voltage (3.0 V to 3.6 V)
7	Q3	(LV)CMOS/(LV)TTL Output	Clock Output 3
8	Q4	(LV)CMOS/(LV)TTL Input	Clock Output 4
_	EP	Thermal Exposed Pad	(DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open.

Table 2. OE, OUTPUT ENABLE FUNCTION TABLE

Inp	uts	Outputs
IN	OE	
L	L	L
Н	L	L
L	Н	L
Н	Н	Н

Table 3. ATTRIBUTES

Characterist	Value					
ESD Protection Human Body Model Machine Model		> 2kV > 200 V				
Moisture Sensitivity, Indefinite Time O	Level 3 Level 1					
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-O @ 0.125 in				
Transistor Count 480 Devices						
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test						

1. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{DD}	Positive Power Supply	GND = 0 V		V _{DD} + 0.5V	V
VI	Input Voltage			$\begin{array}{l} \text{GND} - 0.5 \leq \\ \text{V}_{\text{I}} \leq \text{V}_{\text{DD}} + 0.5 \end{array}$	V
T _A	Operating Temperature Range, Industrial			\geq -40 to \leq +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm 0 lfpm 500 lfpm	TSSOP-8 TSSOP-8 DFN-8 DFN-8	143 103 129 84	°C/W
T _{SOL}	Wave Solder Pb-Free	(Note 2)		265	°C
θ_{JC}	Thermal Resistance (Junction-to-Case)	(Note 2)	DFN8	35 to 40	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

2. JEDEC standard multilayer board - 2S2P (2 signal, 2 power)

NB3N2304NZ

Symbol	Characteristic		Min	Тур	Max	Unit
I _{DD}	Power Supply Current @ 66.66 MHz, Unloaded Outputs			12	25	mA
V _{OH}	Output HIGH Voltage	– IOH = –24 mA –IOH = –12 mA	2.0 2.4			V
V _{OL}	Output LOW Voltage	-IOL = 24 mA -IOL = 12 mA			0.8 0.55	V
VIH	Input HIGH Voltage, IN and OE (Note 3)		2.0			V
V _{IL}	Input LOW Voltage, IN and OE (Note 3)				0.8	V
I _{IH}	Input HIGH Current, V _{IN} = V _{DD}		-50		50	μΑ
IIL	Input LOW Current, V _{IN} = 0 V		-100		100	μΑ
CIN	Input Capacitance, IN, OE			5	7	pF

Table 5. DC CHARACTERISTICS V_{DD} = 3.0 V to 3.6 V, GND = 0 V, T_A = -40° C to $+85^{\circ}$ C

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. IN input has a threshold voltage of $V_{DD}/2$.

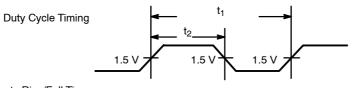
Symbol	Characteristic		Min	Тур	Max	Unit
f _{in}	Input Clock Frequency		DC		140	MHz
t _{DCskew}	kew Duty Cycle Skew = t2 ÷ t1 (Figure 4) Measured at 1.5 V		40	50	60	%
tr/tf	Output Rise and Fall Times; 0.8 V to 2.0 V	C _L = 25 pF C _L = 10 pF		0.9 0.6	1.5	ns
t _{pd}	Propagation Delay, IN-to-Qn (Note 5)		2.5	3.5	5	ns
t _{skew}	Output-to-Output Skew; (Note 5)				100	ps
t _{pu}	Powerup Time for V _{DD} to Reach Minimum Specified Vol	tage	0.05		50	ms

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

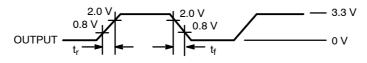
4. All outputs loaded equally with C_L = 25 pF to GND. Duty cycle out = duty in. A 0.01 μ F decoupling capacitor should be connected between V_{DD} and GND.

5. Measured on rising edges at V_{DD} ÷ 2; all outputs with equal loading.

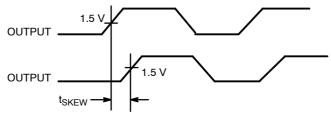
NB3N2304NZ



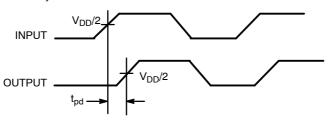
All Outputs Rise/Fall Time



Output-Output Skew



Input-Output Propagation Delay



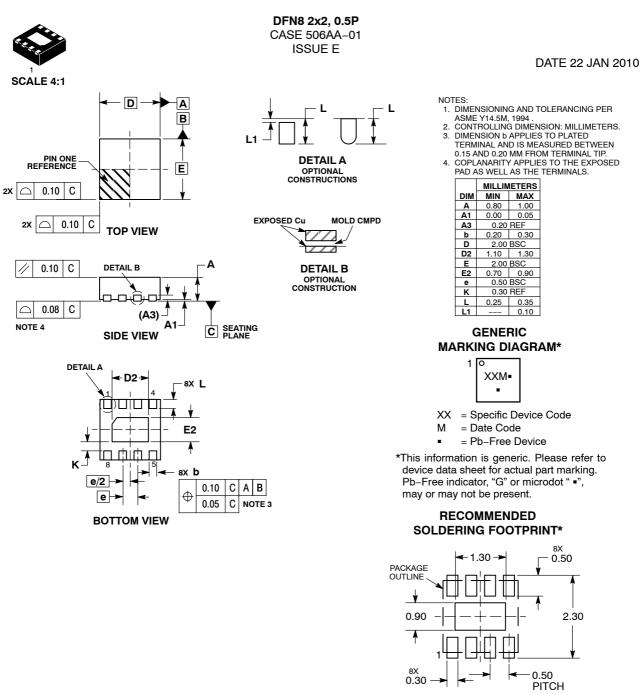


ORDERING INFORMATION

Device	Package	Shipping [†]
NB3N2304NZDTG	TSSOP-8 (Pb-Free)	100 Units / Rail
NB3N2304NZDTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel
NB3N2304NZMNR4G*	DFN8 (Pb-Free)	1000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *Contact a sales representative.





DIMENSIONS: MILLIMETERS

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

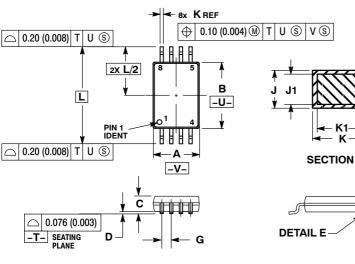
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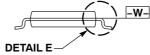


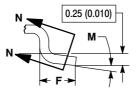
TSSOP-8 CASE 948S-01 ISSUE C

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SECTION N-N





DETAIL E

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

- VIMENSIONING AND TOLENANDING FER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH.
- PROTRUSION SHALL NOT EXCEED 0.15
 (0.006) PER SIDE.
 JIMENSION B DOES NOT INCLUDE INTERLEAD
 FLASH OR PROTRUSION. INTERLEAD FLASH OR
 PROTRUSION SHALL NOT EXCEED 0.25 (0.010)
 DED SIDE.
- PER SIDE 5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.114	0.122
В	4.30	4.50	0.169	0.177
C		1.10		0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.70	0.020	0.028
G	0.65 BSC		0.026 BSC	
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40		0.252	BSC
М	0°	8°	0°	8°

GENERIC **MARKING DIAGRAM***

0	XXX	
	YWW	
	A •	
	•	

XXX = Specific Device Code А

- = Assembly Location
- = Year

Y

- WW = Work Week
- = Pb-Free Package -

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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